

REMARKS

After introduction of the amendment set forth above, claims 1-17 will be pending in the application of which claim 1 is independent. Claims 1-15 and 17 have been amended to eliminate multiple dependency of the claims and to correct grammatical errors. Support for the new claims can be found throughout the original application as filed. *See*, for instance, the claims as originally filed. Applicants submit that no new matter has been introduced by the amendment.

Respectfully submitted,

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Enclosure: Appendix

APPENDIX

VERSION WITH MARKINGS SHOWING CHANGES MADE

IN THE CLAIMS:

The claims are amended as follows:

1. (Amended) A moisture-activated adhesive composition comprising the reaction product of:

- (C) a polyisocyanate selected from (a) a blend of polymeric MDI and pure MDI and ~~and~~ **[/or from]** (b) an isocyanate terminated prepolymer ~~and~~ **[.]; and**
- (D) an isocyanate-reactive component comprising at least one aliphatic tertiary amine group-containing polyol made by alkoxylation of amines or aminoalcohols;

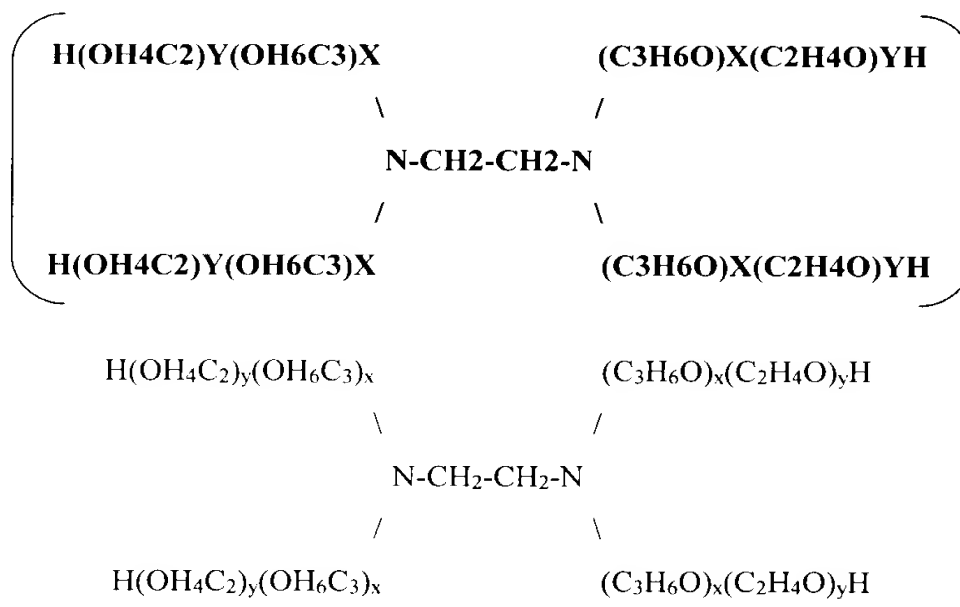
[characterized in that the total ethylene oxide content by weight of the total adhesive composition is more than 2.5%] wherein said adhesive composition has a total ethylene oxide content of more than 2.5% relative to the total adhesive composition.

2. (Amended) **[A]** The moisture-activated adhesive composition according to claim 1, whereby at least 40% of the total ethylene oxide content is present as part of the reactant.
3. (Amended) **[A]** The moisture-activated adhesive composition according to **[claims 1-2]** claim 1, whereby the weight ratio of ethylene oxide to propylene oxide is at least 1 to 8, said propylene oxide being part of the reactant and/or from an additional polyol being present in the composition.
4. (Amended) **[A]** The moisture-activated adhesive composition according to **[claims 1-3]** claim 1, whereby the total nitrogen concentration of the total composition is from 0.002 to 0.05 eqN/100 g.
5. (Amended) **[A]** The moisture-activated adhesive composition according to **[claims**

1-4] claim 1, wherein said polymeric polyisocyanate is a polymeric diphenylmethane diisocyanate.

6. (Amended) [A] The moisture-activated adhesive composition according to [claims 1-5] claim 1, wherein said composition comprises an isocyanate-terminated prepolymer having an NCO content of 10 to 29%.
7. (Amended) [A] The moisture-activated adhesive composition according to claim 6, wherein said isocyanate-terminated prepolymer is the reaction product of polymeric diphenylmethane diisocyanate and a polyether polyol having a molecular weight of from 1000 to 6000.
8. (Amended) [A] The moisture-activated adhesive composition according to claim 1, wherein said reactant is an aliphatic tertiary amine group-containing polyol having an ethylene oxide content of 1 to 90%.
9. (Amended) [A] The moisture-activated adhesive composition according to claim 8, wherein said aliphatic tertiary amine group-containing polyol has an ethylene oxide content of 5 to 60%.
10. (Amended) [A] The moisture-activated adhesive composition according to claim 1, wherein said aliphatic tertiary amine group-containing polyol has a molecular weight of 1500 to 10,000 and comprises an initiator having 1 to 18 carbon atoms.
11. (Amended) [A] The moisture-activated adhesive composition according to claim 1, wherein said aliphatic tertiary amine group-containing polyol is prepared from a compound selected from the group consisting of ethylene diamine, triethylene tetramine and triethanolamine.

12. (Amended) [A] The moisture-activated adhesive composition according to claim 11, wherein said aliphatic tertiary amine group-containing polyol is an ethylene diamine-based polyol having the following formula:



wherein x is an integer of 1 to 29.0 and y is an integer of 0.1 to 10.

13. (Amended) [A] The moisture-activated adhesive composition according to claim 1, further comprising a catalyst.
14. (Amended) A process for bonding multiple substrates comprising:
- (5) applying to a surface of a first substrate a moisture-activated adhesive composition as defined in [**any one of the preceding claims**] claim 1,
 - (6) contacting said surface with a surface of a second substrate,
 - (7) applying pressure to the contacted surfaces, and
 - (8) curing said adhesive composition.
15. (Amended) [A] The process according to claim 14, wherein at least one said substrate has a moisture content of at least 7% by weight.

17. (Amended) [A] The process for bonding according to claim 16, wherein additional moisture is applied to the first substrate surface, the surface of the applied adhesive and/or the surface.